

|                     |                |
|---------------------|----------------|
| $V_{DSS}$           | 250V           |
| $R_{DS(on)}$ (Max.) | 1360m $\Omega$ |
| $I_D$               | 5.0A           |
| $P_D$               | 30W            |

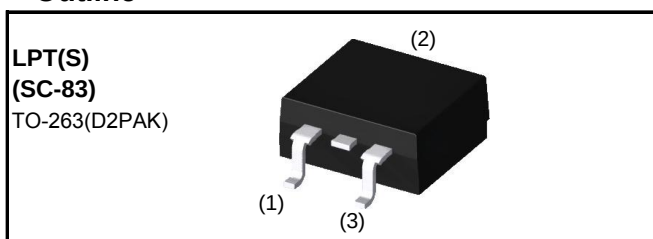
### ●Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Drive circuits can be simple.
- 4) Parallel use is easy.
- 5) Pb-free lead plating ; RoHS compliant
- 6) 100% Avalanche tested

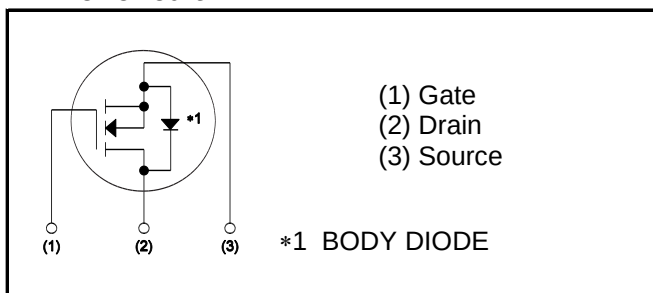
### ●Application

Switching Power Supply  
Automotive Motor Drive  
Automotive Solenoid Drive

### ●Outline



### ●Inner circuit



### ●Packaging specifications

| Type | Packaging                 | Taping    |
|------|---------------------------|-----------|
|      | Reel size (mm)            | 330       |
|      | Tape width (mm)           | 24        |
|      | Basic ordering unit (pcs) | 1,000     |
|      | Taping code               | TL        |
|      | Marking                   | RCJ050N25 |

### ●Absolute maximum ratings( $T_a = 25^\circ\text{C}$ )

| Parameter                      |                               | Symbol             | Value       | Unit             |
|--------------------------------|-------------------------------|--------------------|-------------|------------------|
| Drain - Source voltage         |                               | $V_{DSS}$          | 250         | V                |
| Continuous drain current       | $T_c = 25^\circ\text{C}$      | $I_D^{*1}$         | $\pm 5.0$   | A                |
|                                | $T_c = 100^\circ\text{C}$     | $I_D^{*1}$         | $\pm 2.7$   | A                |
| Pulsed drain current           |                               | $I_{D,pulse}^{*2}$ | $\pm 20$    | A                |
| Gate - Source voltage          |                               | $V_{GSS}$          | $\pm 30$    | V                |
| Avalanche energy, single pulse |                               | $E_{AS}^{*3}$      | 1.82        | mJ               |
| Avalanche current              |                               | $I_{AR}^{*3}$      | 2.5         | A                |
| Power dissipation              | $T_c = 25^\circ\text{C}$      | $P_D$              | 30          | W                |
|                                | $T_a = 25^\circ\text{C}^{*4}$ | $P_D$              | 1.56        | W                |
| Junction temperature           |                               | $T_j$              | 150         | $^\circ\text{C}$ |
| Range of storage temperature   |                               | $T_{stg}$          | -55 to +150 | $^\circ\text{C}$ |

### ●Thermal resistance

| Parameter                                            | Symbol     | Values |      |      | Unit |
|------------------------------------------------------|------------|--------|------|------|------|
|                                                      |            | Min.   | Typ. | Max. |      |
| Thermal resistance, junction - case                  | $R_{thJC}$ | -      | -    | 4.16 | °C/W |
| Thermal resistance, junction - ambient <sup>*4</sup> | $R_{thJA}$ | -      | -    | 80   | °C/W |
| Soldering temperature, wavesoldering for 10s         | $T_{sold}$ | -      | -    | 265  | °C   |

### ●Electrical characteristics( $T_a = 25^\circ\text{C}$ )

| Parameter                                   | Symbol            | Conditions                                               | Values |      |          | Unit          |
|---------------------------------------------|-------------------|----------------------------------------------------------|--------|------|----------|---------------|
|                                             |                   |                                                          | Min.   | Typ. | Max.     |               |
| Drain - Source breakdown voltage            | $V_{(BR)DSS}$     | $V_{GS} = 0V, I_D = 1mA$                                 | 250    | -    | -        | V             |
| Zero gate voltage drain current             | $I_{DSS}$         | $V_{DS} = 250V, V_{GS} = 0V$<br>$T_j = 25^\circ\text{C}$ | -      | -    | 10       | $\mu\text{A}$ |
| Gate - Source leakage current               | $I_{GSS}$         | $V_{GS} = \pm 30V, V_{DS} = 0V$                          | -      | -    | $\pm 10$ | nA            |
| Gate threshold voltage                      | $V_{GS(th)}$      | $V_{DS} = 10V, I_D = 1mA$                                | 3.5    | -    | 5.5      | V             |
| Static drain - source on - state resistance | $R_{DS(on)}^{*5}$ | $V_{GS} = 10V, I_D = 2.5A$                               | -      | 970  | 1360     | m $\Omega$    |
|                                             |                   | $V_{GS} = 10V, I_D = 2.5A$<br>$T_j = 125^\circ\text{C}$  | -      | 2100 | 2950     |               |
| Forward transfer admittance                 | $g_{fs}$          | $V_{DS} = 10V, I_D = 2.5A$                               | 1.25   | 2.50 | -        | S             |

**●Electrical characteristics**( $T_a = 25^\circ\text{C}$ )

| Parameter                    | Symbol            | Conditions                          | Values |      |      | Unit |
|------------------------------|-------------------|-------------------------------------|--------|------|------|------|
|                              |                   |                                     | Min.   | Typ. | Max. |      |
| Input capacitance            | $C_{iss}$         | $V_{GS} = 0V$                       | -      | 350  | -    | pF   |
| Output capacitance           | $C_{oss}$         | $V_{DS} = 25V$                      | -      | 30   | -    |      |
| Reverse transfer capacitance | $C_{rss}$         | $f = 1\text{MHz}$                   | -      | 15   | -    |      |
| Turn - on delay time         | $t_{d(on)}^{*5}$  | $V_{DD} \approx 125V, V_{GS} = 10V$ | -      | 15   | -    | ns   |
| Rise time                    | $t_r^{*5}$        | $I_D = 2.5A$                        | -      | 16   | -    |      |
| Turn - off delay time        | $t_{d(off)}^{*5}$ | $R_L = 49.9\Omega$                  | -      | 18   | -    |      |
| Fall time                    | $t_f^{*5}$        | $R_G = 10\Omega$                    | -      | 10   | -    |      |

**●Gate Charge characteristics**( $T_a = 25^\circ\text{C}$ )

| Parameter            | Symbol          | Conditions                        | Values |      |      | Unit |
|----------------------|-----------------|-----------------------------------|--------|------|------|------|
|                      |                 |                                   | Min.   | Typ. | Max. |      |
| Total gate charge    | $Q_g^{*5}$      | $V_{DD} \approx 125V$             | -      | 8.5  | -    | nC   |
| Gate - Source charge | $Q_{gs}^{*5}$   | $I_D = 5.0A$                      | -      | 3.5  | -    |      |
| Gate - Drain charge  | $Q_{gd}^{*5}$   | $V_{GS} = 10V$                    | -      | 3.5  | -    |      |
| Gate plateau voltage | $V_{(plateau)}$ | $V_{DD} \approx 125V, I_D = 5.0A$ | -      | 8.0  | -    | V    |

**●Body diode electrical characteristics** (Source-Drain)( $T_a = 25^\circ\text{C}$ )

| Parameter                 | Symbol        | Conditions                | Values |      |      | Unit |
|---------------------------|---------------|---------------------------|--------|------|------|------|
|                           |               |                           | Min.   | Typ. | Max. |      |
| Continuous source current | $I_S^{*1}$    | $T_c = 25^\circ\text{C}$  | -      | -    | 5.0  | A    |
| Pulsed source current     | $I_{SM}^{*2}$ |                           | -      | -    | 20   | A    |
| Forward voltage           | $V_{SD}^{*5}$ | $V_{GS} = 0V, I_S = 5.0A$ | -      | -    | 1.5  | V    |
| Reverse recovery time     | $t_{rr}^{*5}$ | $I_S = 2.5A$              | -      | 90   | -    | ns   |
| Reverse recovery charge   | $Q_{rr}^{*5}$ | $di/dt = 100A/\mu s$      | -      | 225  | -    | nC   |

\*1 Limited only by maximum temperature allowed.

\*2  $P_w \leq 10\mu s$ , Duty cycle  $\leq 1\%$

\*3  $L \approx 500\mu H$ ,  $V_{DD} = 50V$ ,  $R_g = 25\Omega$ , starting  $T_j = 25^\circ\text{C}$

\*4 Mounted on a epoxy PCB FR4 (25mm  $\times$  27mm  $\times$  0.8mm)

\*5 Pulsed

●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

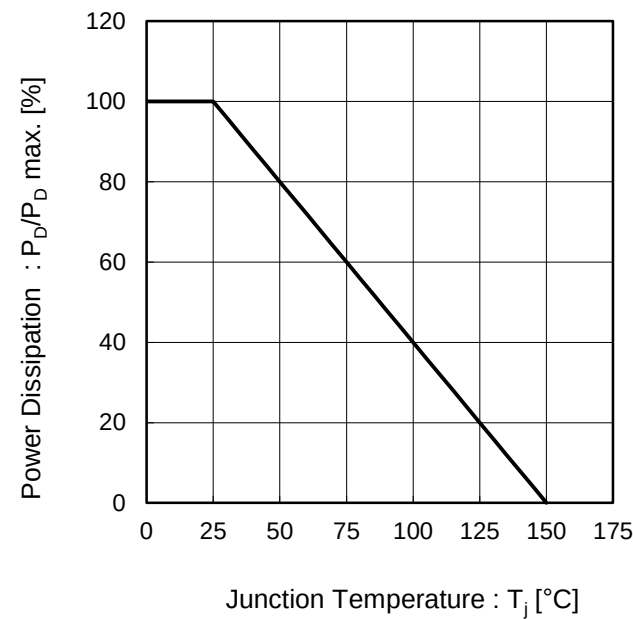


Fig.2 Maximum Safe Operating Area

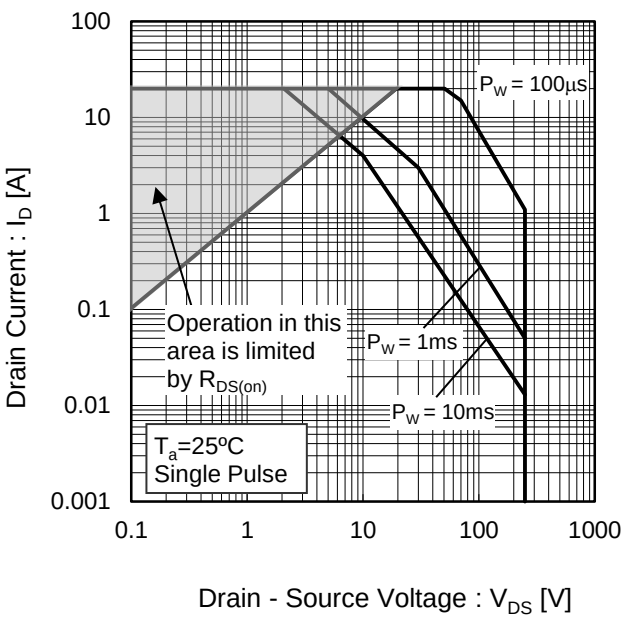
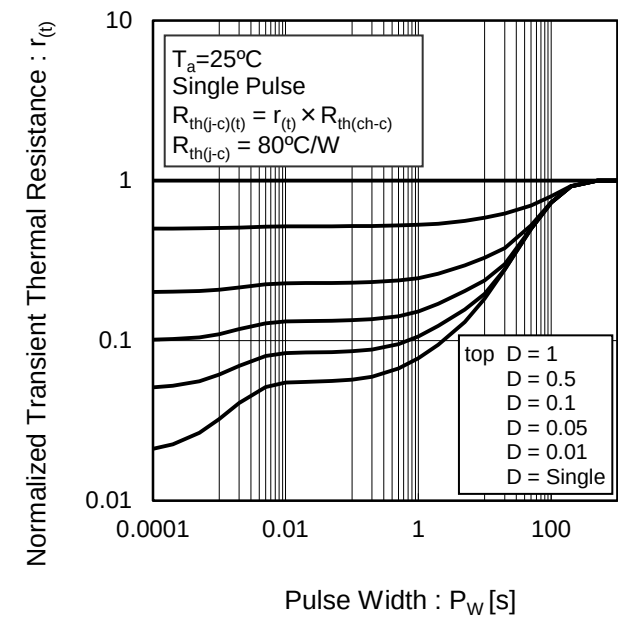


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width



●Electrical characteristic curves

Fig.4 Avalanche Current vs Inductive Load

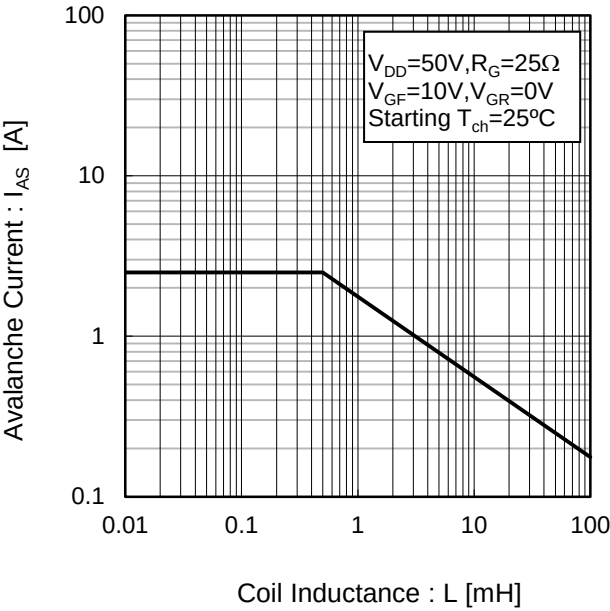


Fig.5 Avalanche Energy Derating Curve vs Junction Temperature

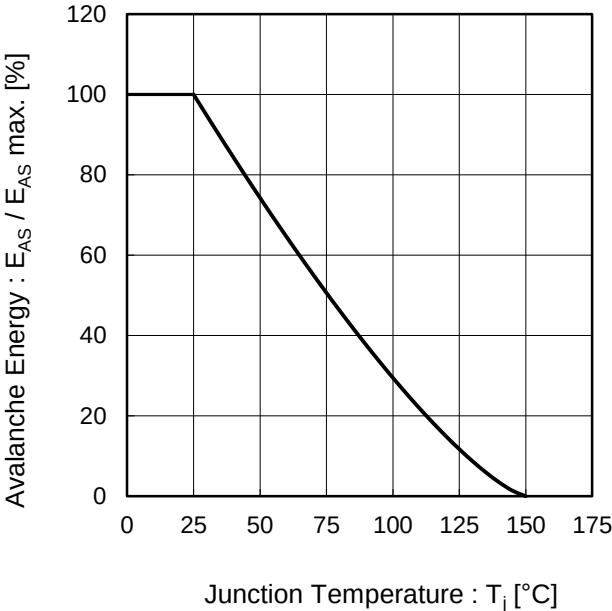


Fig.6 Typical Output Characteristics(I)

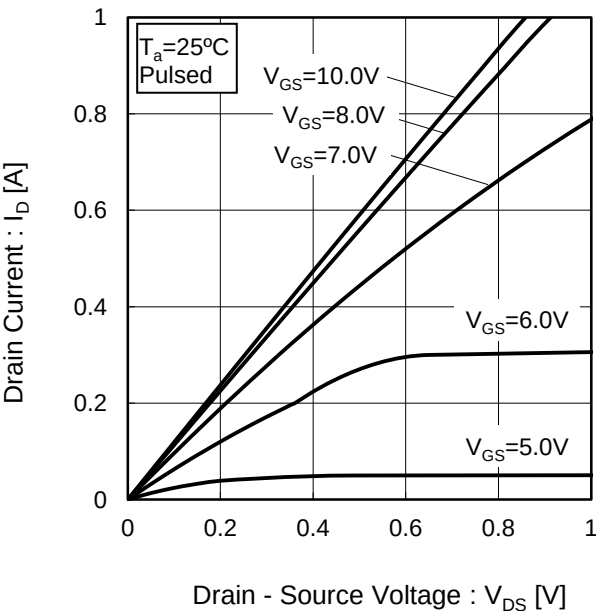
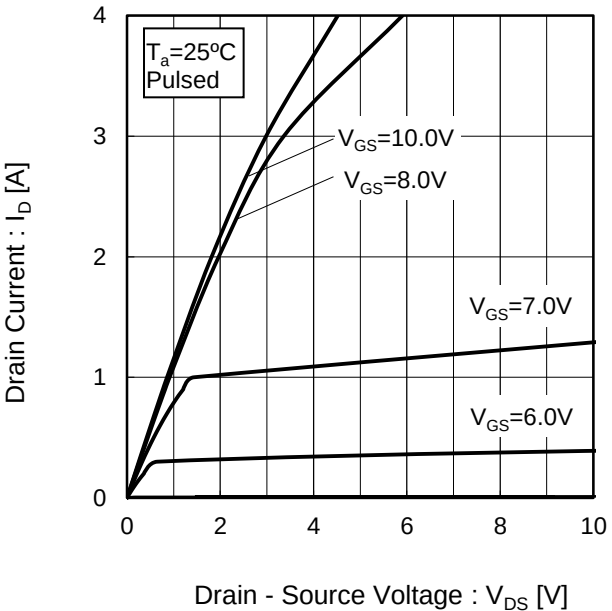


Fig.7 Typical Output Characteristics(II)



●Electrical characteristic curves

Fig.8 Breakdown Voltage  
vs. Junction Temperature

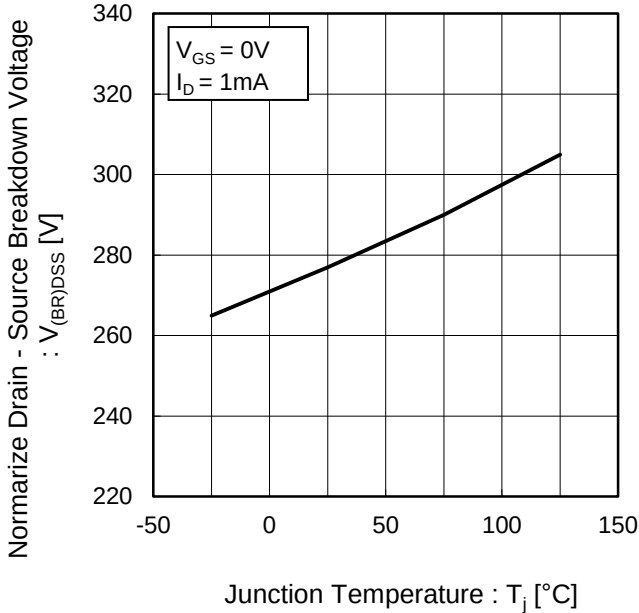


Fig.9 Typical Transfer Characteristics

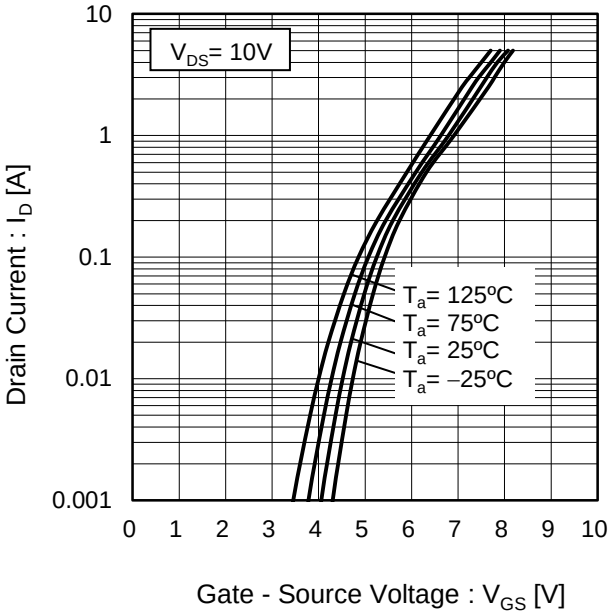


Fig.10 Gate Threshold Voltage  
vs. Junction Temperature

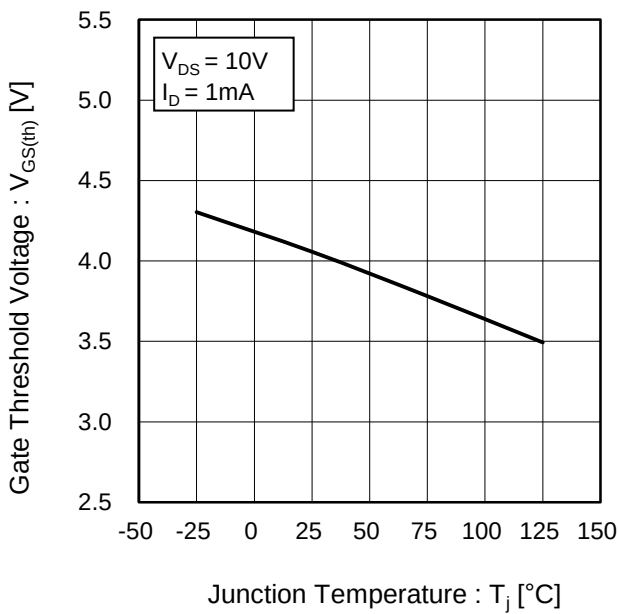
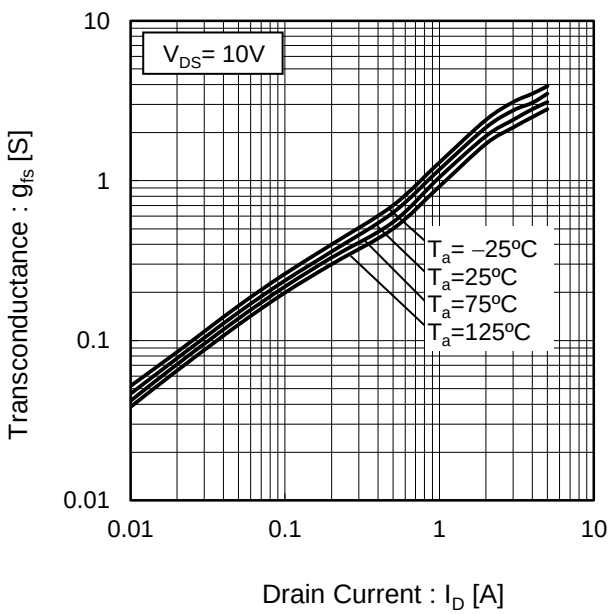


Fig.11 Transconductance vs. Drain Current



●Electrical characteristic curves

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

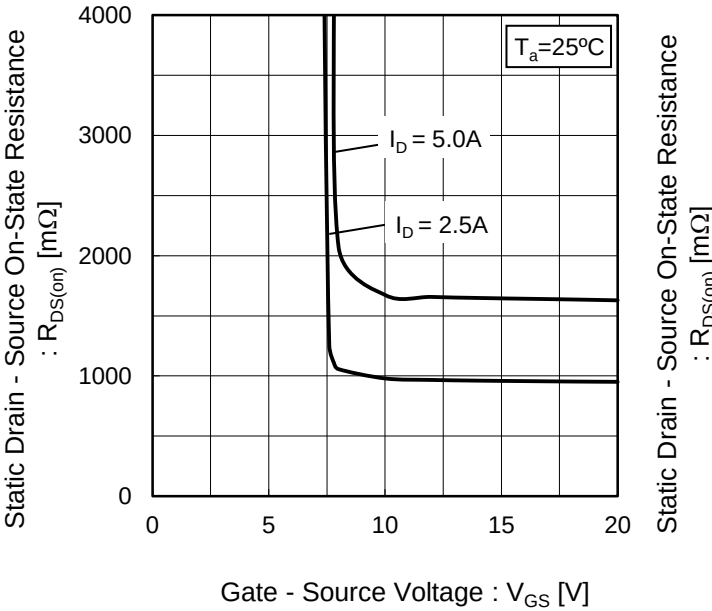


Fig.13 Static Drain - Source On - State Resistance vs. Drain Current(I)

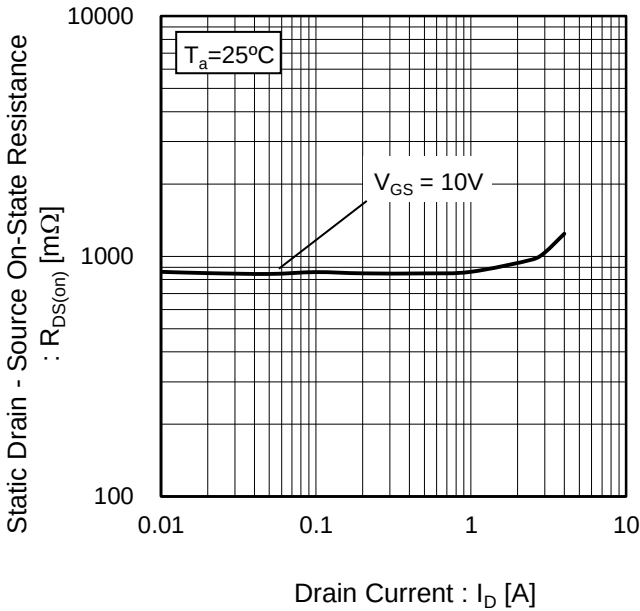
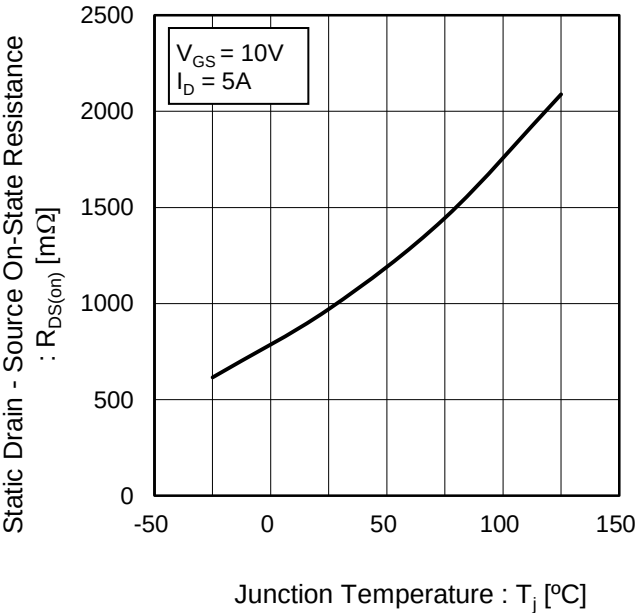


Fig.14 Static Drain - Source On - State Resistance vs. Junction Temperature



●Electrical characteristic curves

Fig.15 Static Drain - Source On - State Resistance vs. Drain Current(II)

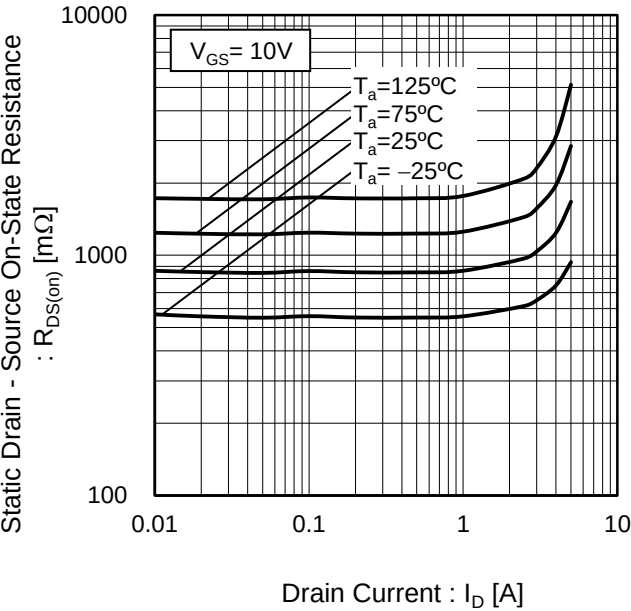
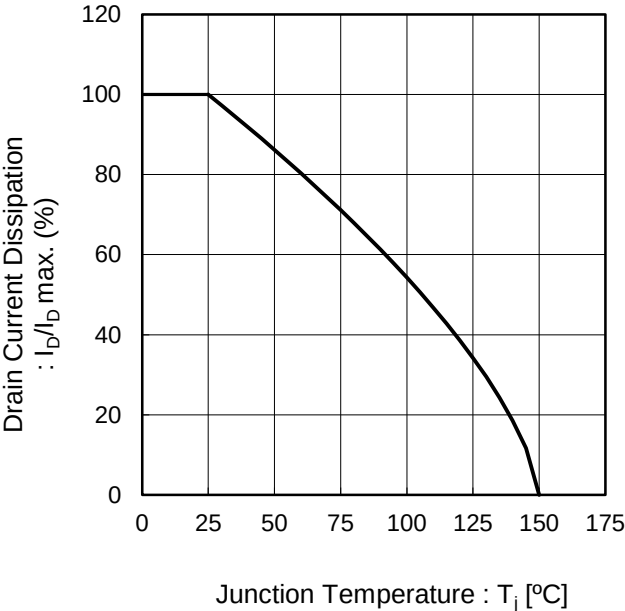


Fig.16 Drain Current Derating Curve





●Electrical characteristic curves

Fig.17 Typical Capacitance vs. Drain - Source Voltage

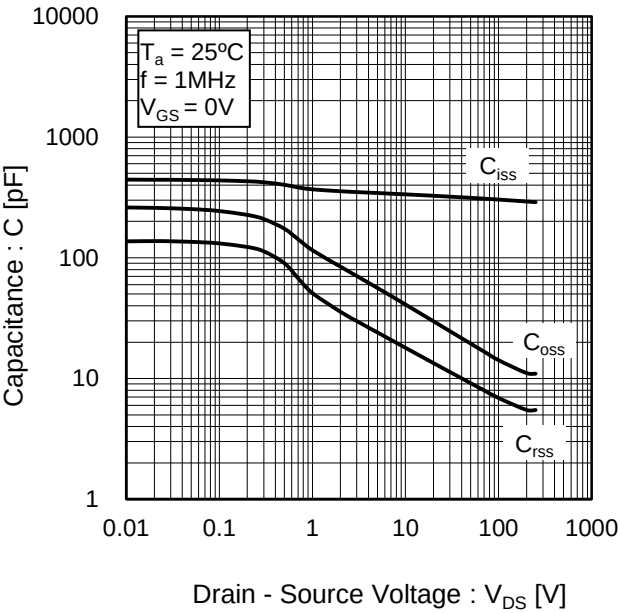


Fig.18 Switching Characteristics

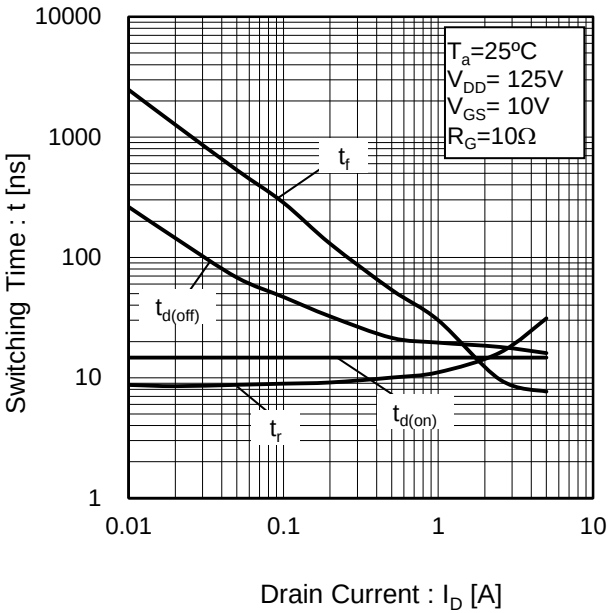
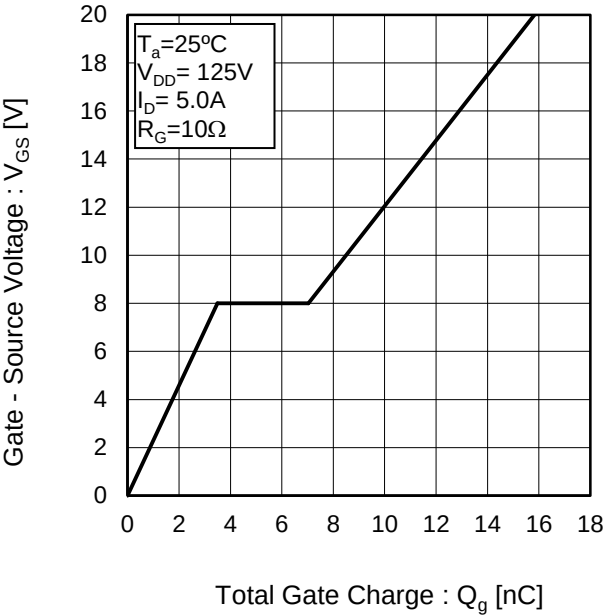


Fig.19 Dynamic Input Characteristics



●Electrical characteristic curves

Fig.20 Source Current  
vs. Source - Drain Voltage

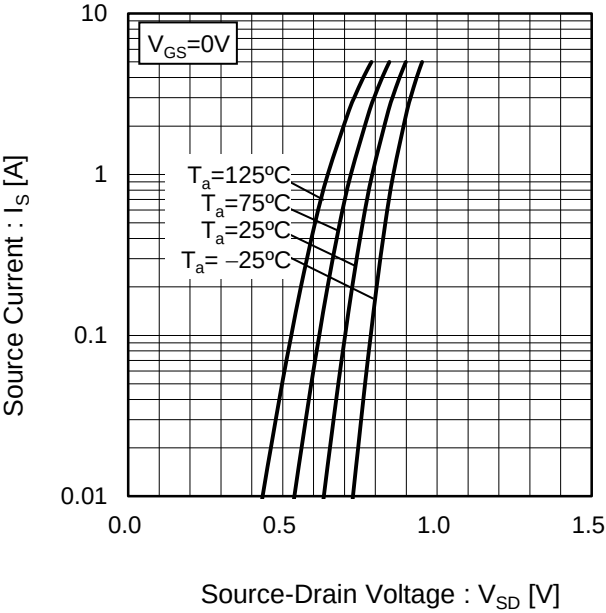
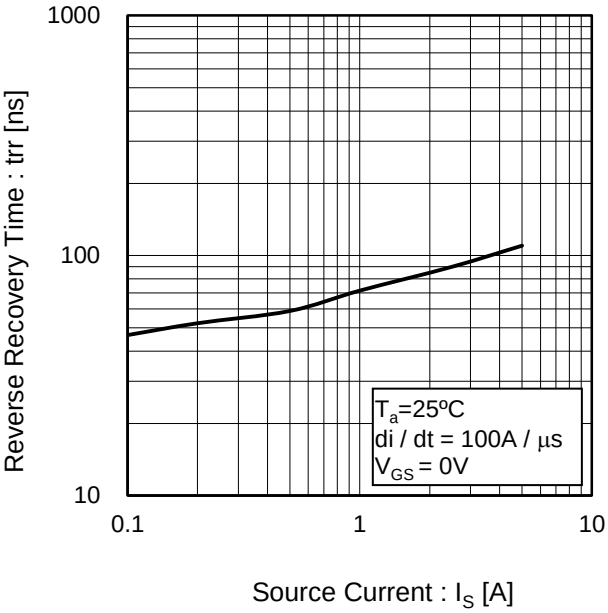


Fig.21 Reverse Recovery Time  
vs. Source Current



●Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

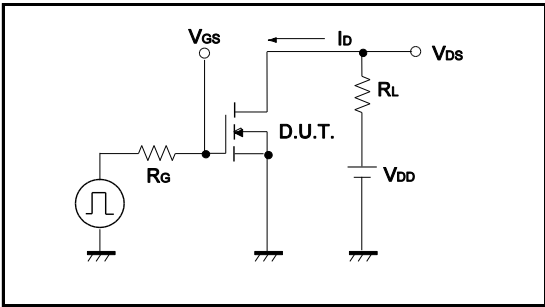


Fig.1-2 Switching Waveforms

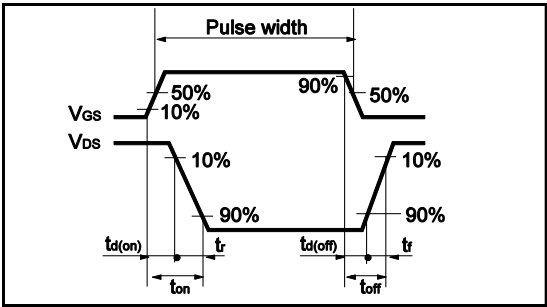


Fig.2-1 Gate Charge Measurement Circuit

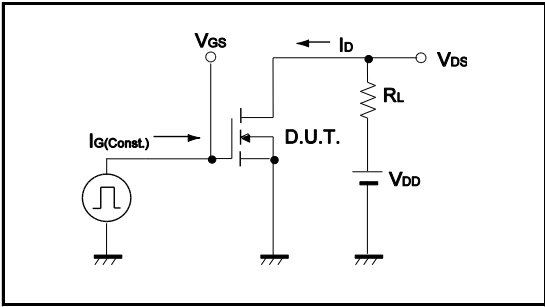


Fig.2-2 Gate Charge Waveform

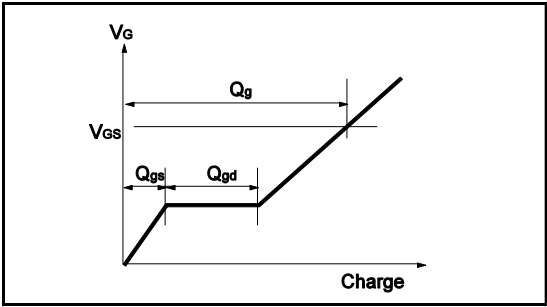


Fig.3-1 Avalanche Measurement Circuit

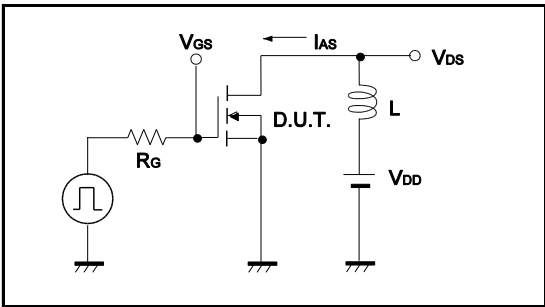
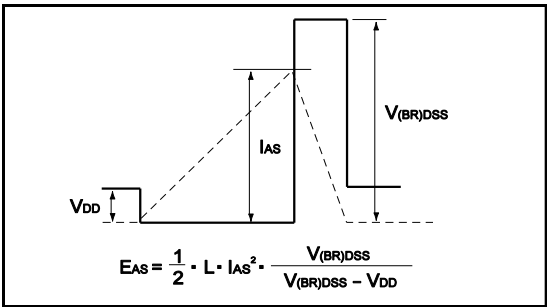
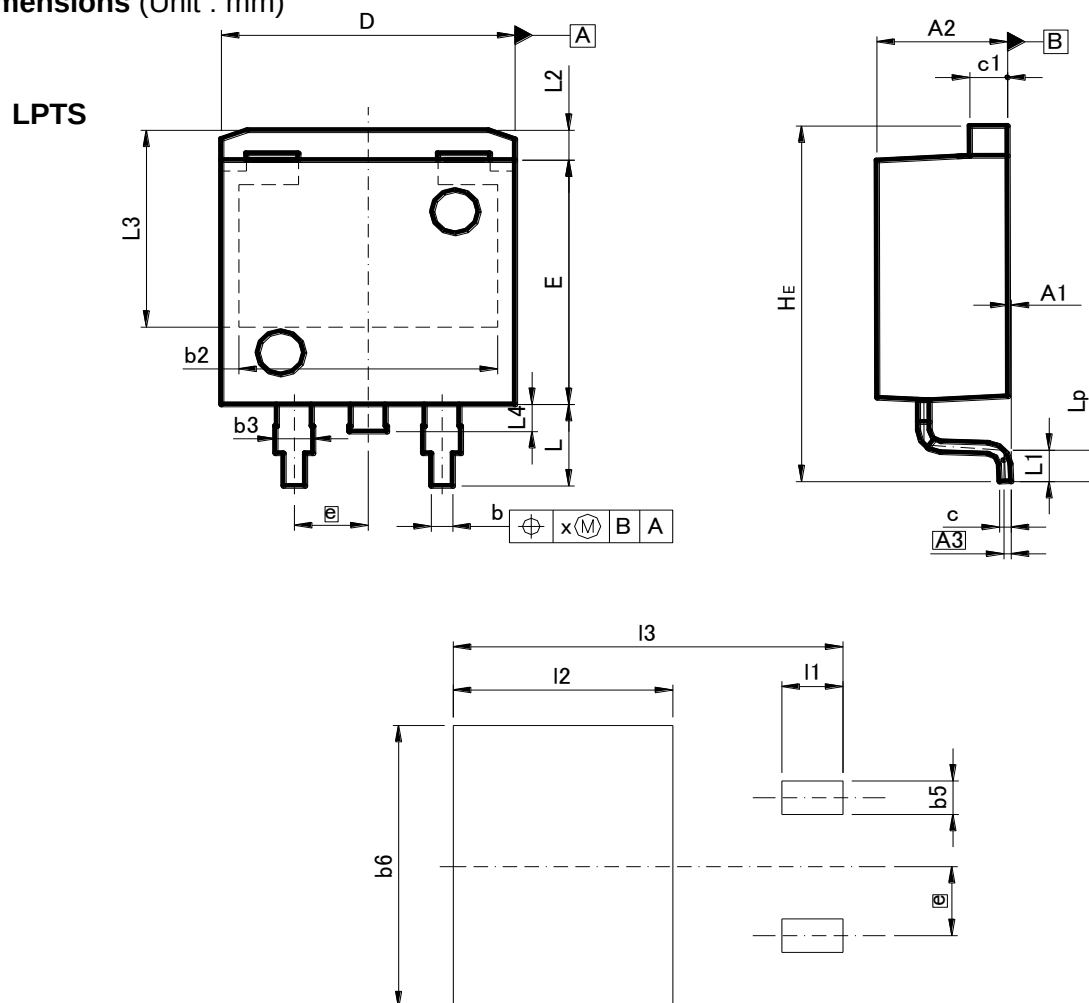


Fig.3-2 Avalanche Waveform



## ●Dimensions (Unit : mm)



Pattern of terminal position areas

| DIM | MILIMETERS |       | INCHES |       |
|-----|------------|-------|--------|-------|
|     | MIN        | MAX   | MIN    | MAX   |
| A1  | 0.00       | 0.30  | 0      | 0.012 |
| A2  | 4.30       | 4.70  | 0.169  | 0.185 |
| A3  | 0.25       |       | 0.01   |       |
| b   | 0.68       | 0.98  | 0.027  | 0.039 |
| b2  | 8.90       |       | 0.35   |       |
| b3  | 1.14       | 1.44  | 0.045  | 0.057 |
| c   | 0.30       | 0.60  | 0.012  | 0.024 |
| c1  | 1.10       | 1.50  | 0.043  | 0.059 |
| D   | 9.80       | 10.40 | 0.386  | 0.409 |
| E   | 8.80       | 9.20  | 0.346  | 0.362 |
| e   | 2.54       |       | 0.10   |       |
| HE  | 12.80      | 13.40 | 0.504  | 0.528 |
| L   | 2.70       | 3.30  | 0.106  | 0.13  |
| L1  | 0.90       | 1.50  | 0.035  | 0.059 |
| L2  | 1.10       |       | 0.043  |       |
| L3  | 7.25       |       | 0.285  |       |
| L4  | 1.00       |       | 0.039  |       |
| Lp  | 0.90       | 1.50  | 0.035  | 0.059 |
| x   | —          | 0.25  | —      | 0.01  |

| DIM | MILIMETERS |       | INCHES |       |
|-----|------------|-------|--------|-------|
|     | MIN        | MAX   | MIN    | MAX   |
| b5  | —          | 1.23  | —      | 0.049 |
| b6  | —          | 10.40 | —      | 0.409 |
| I1  | —          | 2.10  | —      | 0.083 |
| I2  | —          | 7.55  | —      | 0.297 |
| I3  | —          | 13.40 | —      | 0.528 |

Dimension in mm/inches

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ВЧ соединители, коаксиальные кабели,  
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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